#

A	2022.08.03	ALL	AOS-AOD4185		

67&'8' P 97:

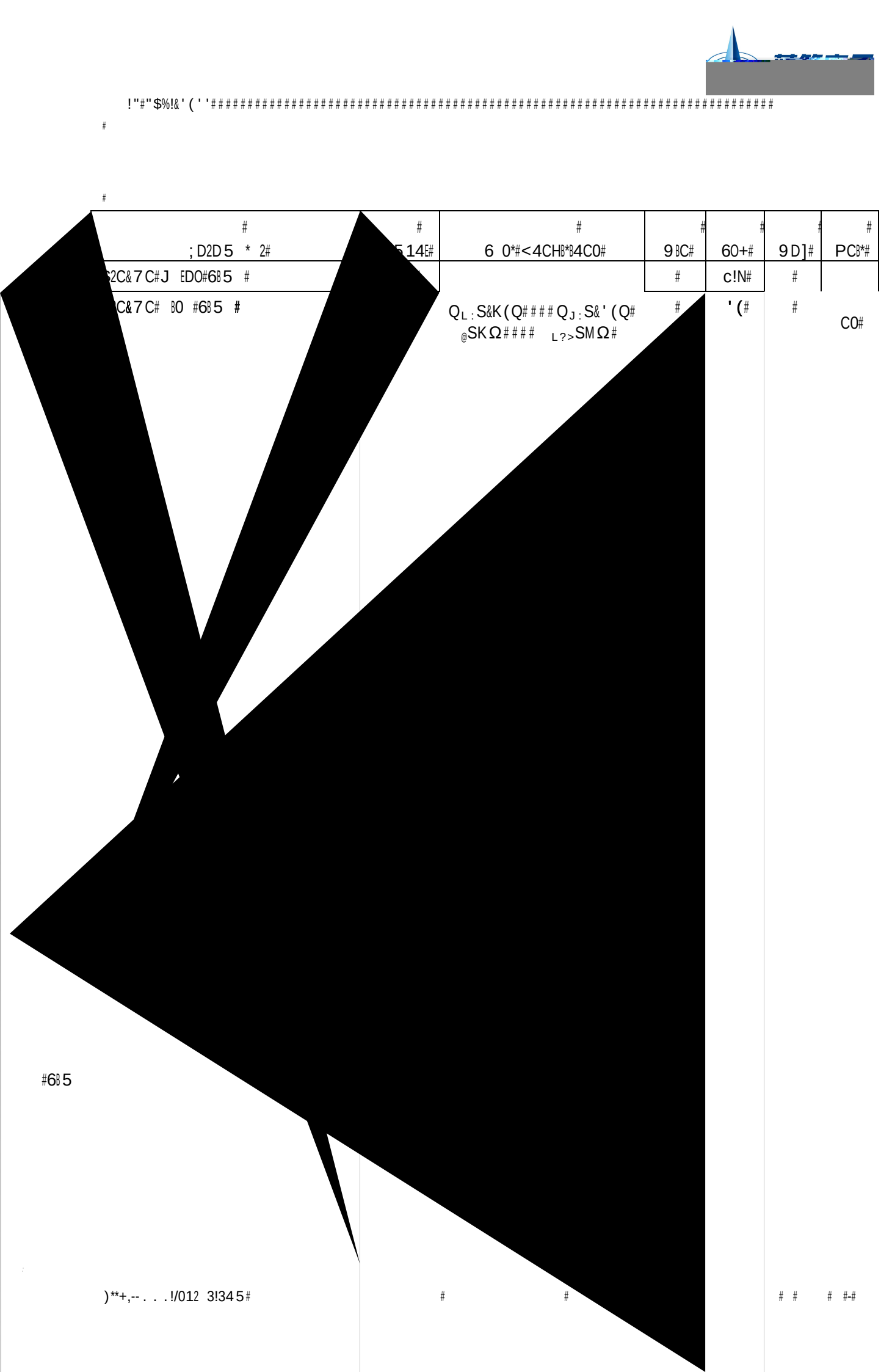
;&<="">>?@#97:A?6#BC#D#67&'8'#;ED0*%3#;D3FD% !#

#

@4.#7C&

!"#"$%!&'(''##

)**+,--. . .!/012 3!345# # # # # #-



!"#"$%!&'(''##

#

#

#	#	#	#	#	#	#
;D2D5 * 2#	514E#	6 0*#<4CHB*B4C0#	9BC#	60+#	9D]#	PCB*#
S2C&7C#J EDO#6B5 #			#	c!N#	#	
C&7C# B0 #6B5 #		QL:S&K(Q####QJ:S&'(Q# @SKΩ#### L?>SMΩ#	#	'(#	#	C0#

#6B5

)**+,--...!/012 3!345# # # # # # #-#

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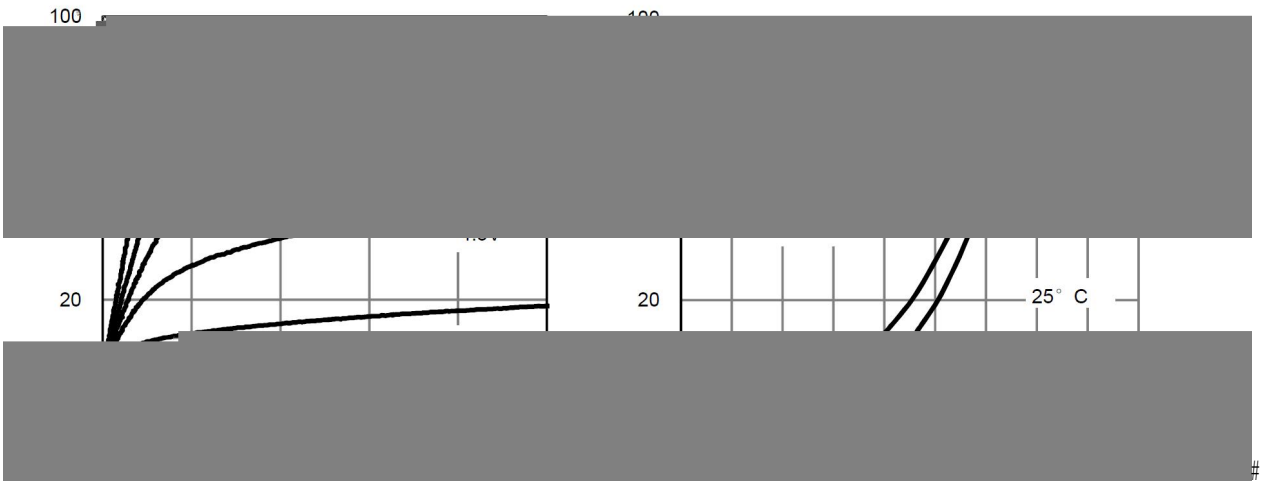
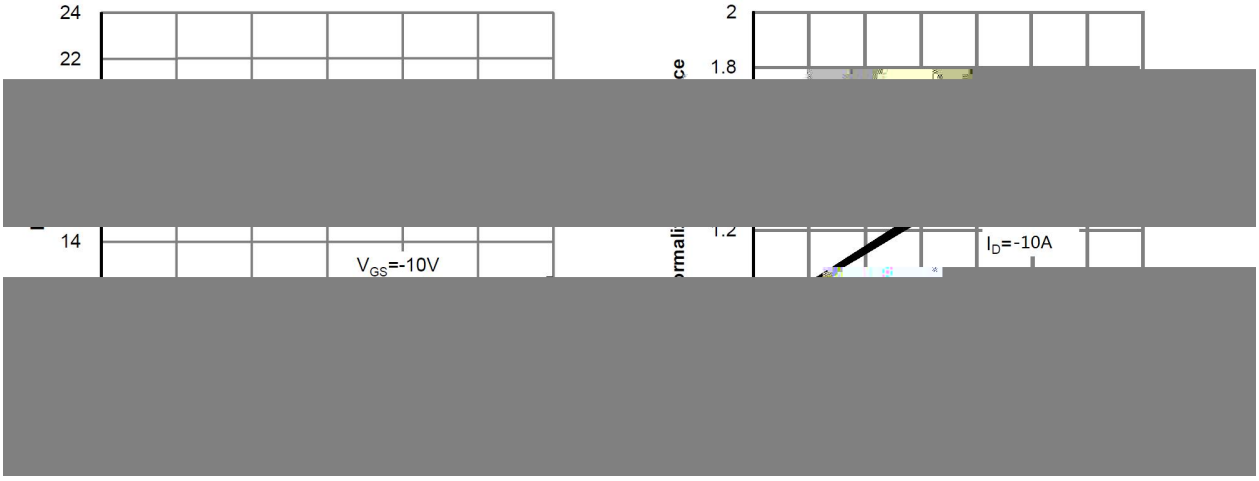
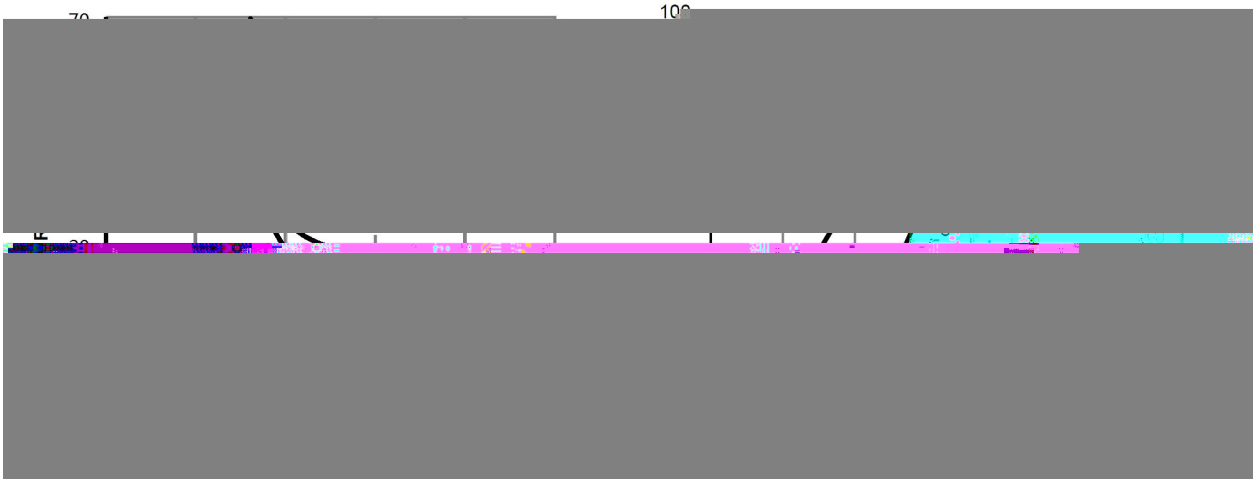

100
20
20
25° C

#


24
22
14
V_{GS}=-10V
2
1.8
1.2
I_D=-10A



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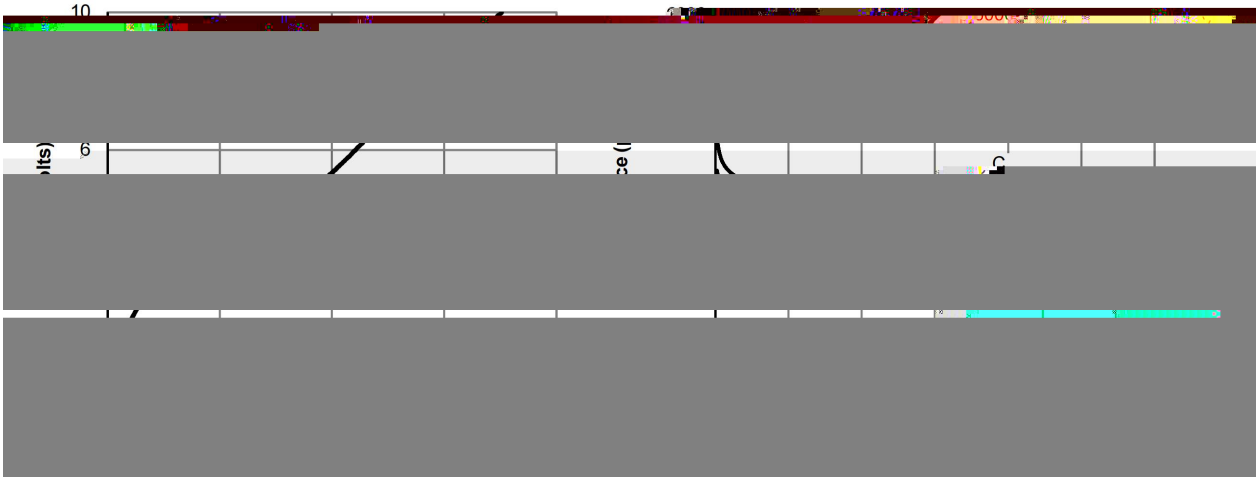

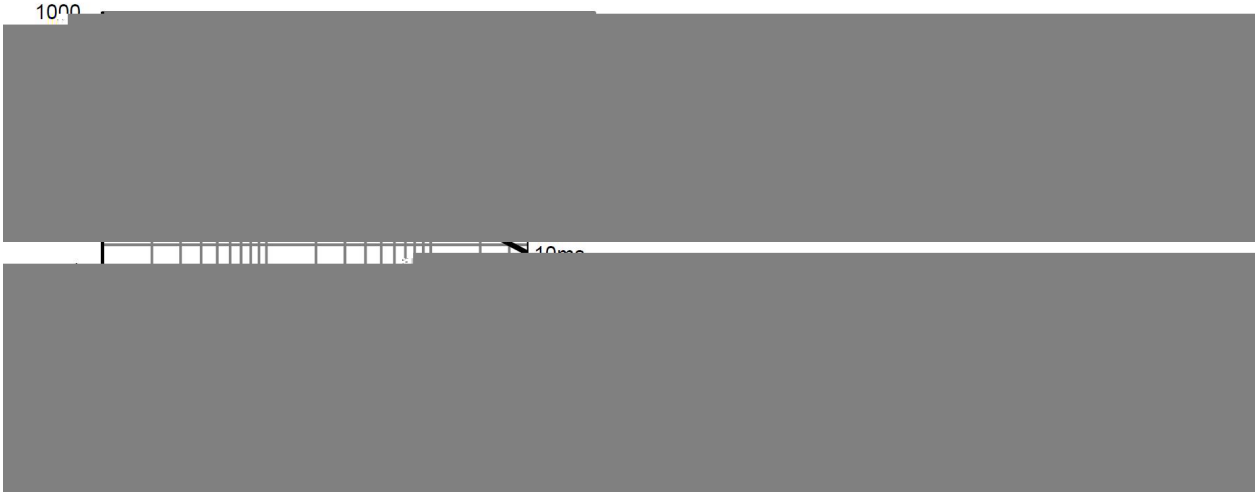

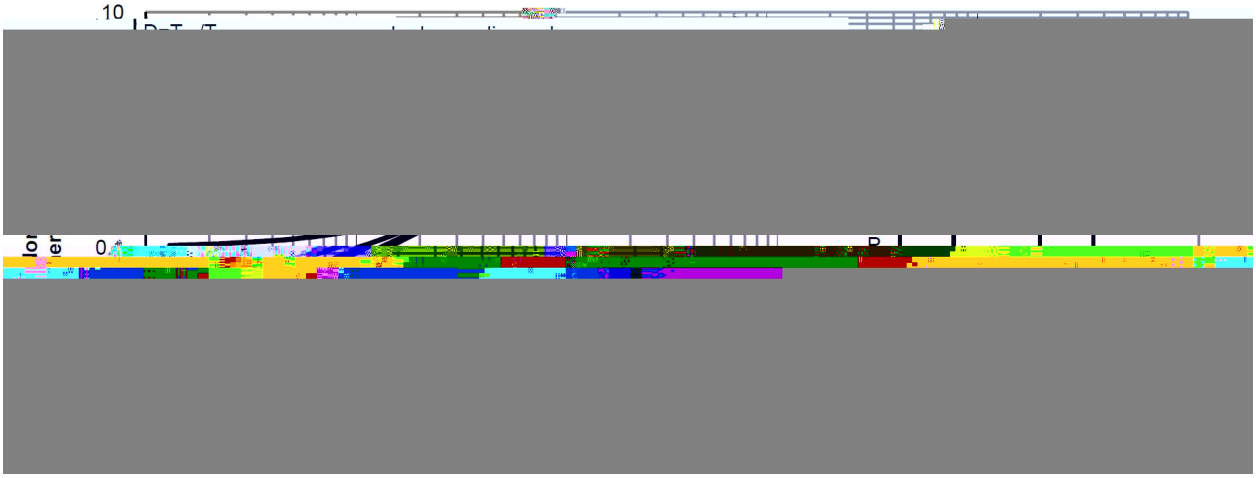

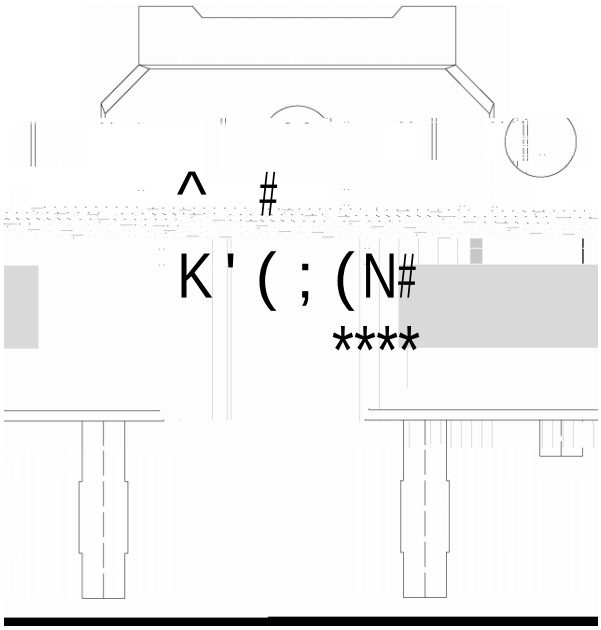

BR

120P04

****

>4* ,#

^ ,### # <45+DCO#<4H #

K'(;(N,# # ;24H$3*#60+ #

ffff,# # # @4*#>4!#<4H G#34H #3)DC% #.B*)#@4*#>4#

!"#"$%!&'(''##
#

Temperature Profile for IR Reflow Soldering(Pb-Free)

>4* ,#

K K8(KV(W(c(0 3g# # # K!;2) D*BC%,K8(hKV(℃G#6B5 ,W(hc(0 3!#

' 'N8±8 8±(!80 3g# # '!; DF#6 5+!,'N8±8℃G#J$2D*B4C,8±(!80 3!#

M ' K(℃-0 3!# # # # M! <44BBC%#:+ H,#'hK(℃-0 3!#

#

'W(±8℃# # K(±K#0 3!# # # # 6 5+!,'W(a8℃# # 6B5 ,K(aK#0 3#

#

##-## ??@#

;D3FD% #60+ # #	PCB*0 #				JB5 C0B4C# #	##R$CB* 5 5MT#	
	Units/Reel 只/卷盘	Reels/Inner Box 卷盘/盒	Units/Inner Box 只/盒	Inner Boxes/Outer Box 盒/箱	Units/Outer Box 只/箱	Reel	Inner Box	Outer Box
TO-252	2,500	2	[redacted]	6	30,000	13″ ×16	360×360×50	380×335×366

##-##6P^?#

;D3FD% #60+ #	PCB*0 #				JB5 C0B4C# #	##R$CB* 5 5MT#		
[redacted]								Outer Box
TO-251/252	75	48	3,600	5	18,000	526×20.5×5.25	555×164×50	4